

### **Crystal Growth: Physics, Technology and Modeling**

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# Lecture 1. Epitaxy - introduction 22 February 2023

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## **Epitaxy - introduction**

### Outline

- definitions
- methods of epitaxial growth
- lattice mismatch
- thermal strain
- antiphase domains (polar on non-polar growth)
- some methods to reduce defect density in lattice mismatched epitaxial structures



### **Definitions**



Epitaxy = growth of monocrystalline layers on the monocrystalline substrate in the way that crystalline structure of the layer is determined by the structure of the substrate



- **Homoepitaxy** = the layer and the substrate are the same
- Heteroepitaxy = the layer and the substrate are different (e.g. they differ by chemical composition)

### Methods of epitaxial growth



• Epitaxy from a gas phase (MBE, VPE, MOVPE, HVPE, ...)  $V_{gr} \sim \mu m/h$ next lectures: Z.R. Żytkiewicz i M. Leszczyński



• Liquid phase epitaxy (LPE, LPEE, ...)  $V_{gr} \sim \mu m/min$ lecture: Z.R. Żytkiewicz 5 April 2023

# **Solid Phase Epitaxy**



### mass transport mechanism – solid state diffusion

### Examples:

### post implantation annealing



Figure 10. Schematic diagrams of the growth process of GaN on sapphire with an AIN buffer layer.



### Lattice mismatch



### limited number of available substrate crystals!!!

epitaxy of layers lattice mismatched to the substrate - the most common case



### Lattice mismatch

assumptions:

$$h_s = \infty$$

$$h_e < h_{cr}$$

$$a_e^{relax} > a_s$$

## before epitaxy



# after epitaxy



$$a_e^{\text{II}} = a_s < a_e^{relax}$$
  
compression in the layer

$$a_e^{\perp} > a_e^{relax}$$

tetragonal lattice distortion

lattice misfit

$$f = (a_e - a_s) / a_s$$

strain energy in the layer

$$E_{el} \propto f^2 \cdot h_e$$

# How to reduce lattice mismatch induced strain energy ?



interdiffusion



- very slow process
- less important in "thick" films
- important in nanostructures

surface deformation



- lattice relaxation at the surface
- important in nanostructures (QDs)
- less important in "thick" films



(misfit dislocations - MD)



epitaxy of **B** on substrate A

separate A and B a(B) > a(A)



(misfit dislocations - MD)



epitaxy of **B** on substrate A

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(misfit dislocations - MD)



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(misfit dislocations - MD)



epitaxy of **B** on substrate A

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(misfit dislocations - MD)



epitaxy of **B** on substrate A

separate A and B a(B) > a(A)

### Generation of misfit dislocations (misfit dislocations - MD)



#### layer with misfit dislocations









# Do we like misfit dislocations ?

#### **Threading dislocations**

#### **Dislocations cannot terminate inside the perfect crystal**



edge dislocations A-D;



MD = misfit dislocation TD = threading dislocation

### TD dislocations induce nonradiative recombination

Lester et al. APL 66 (1995) 1249



Fig. 3 Dependence of LED efficiency on dislocation density for devices made with a wide range of III-V materials [11].





### **Do we like misfit dislocations** ? Threading dislocations

# Lifetime of GaN/InGaN laser diodes as a function of dislocation density (from Sony)







Fig. 6. Average film stress versus Al content data determined by ABAC (open circles and squares) and K $\alpha$ PS (solid circles and squares) techniques. Solid triangle at x = 1.0 is after Ettenberg and Paff<sup>7</sup>).

Fig. 12. Comparison of threshold current density data versus active GaAs layer thickness for lasers with ternary (closed symbols) and quaternary (open symbols) waveguiding layers (see text).



### Thermal strain cont.

• Laser DH GaAlAs/GaAs Rozgonyi, Petroff, Panish JCG <u>27</u> (1974) 106.

### AlGaAs/GaAs -

0.7

considered as an ideal laser system perfect lattice matching

 GaAs on Si cracking of GaAs layers thicker than ~ 10 μm 10<sup>9</sup> dyn/cm<sup>2</sup> = 100 MPa

### Lattice mismatch strain - application



APPLIED PHYSICS LETTERS 89, 223109 (2006)

#### Rolled-up micro- and nanotubes from single-material thin films

R. Songmuang,<sup>a)</sup> Ch. Deneke, and O. G. Schmidt Max-Planck-Institut für Festkörperforschung, Heisenbergstr. 1, D-70569 Stuttgart, Germany

(Received 1 August 2006; accepted 5 October 2006; published online 28 November 2006)

The authors fabricate well-positioned and size-scalable semiconductor micro- and nanotubes from *single-material* layers. The tubes form when a partially strain-relaxed film, grown at low substrate temperatures, is released from the substrate by selective underetching. The layer rolls *downwards* or *upwards* depending on whether it is initially tensile or compressively strained. They create silicon and indium-gallium-arsenide tubes with diameters accurately tunable by varying the layer thickness. They draw a simple model to describe the mechanism responsible for the tube formation from a single-material thin film. Moreover, the tube diameters are shown to scale with strain and layer thickness. © 2006 American Institute of Physics. [DOI: 10.1063/1.2390647]





#### after release by etching



Si substrate



**GaAs substrate** 

(c) Contraction

Expansion

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# Antiphase domains (polar on nonpolar)

(antiphase domain boundaries - APB)





some tricks are needed (e.g. annealing of Si (111) substrate) to reduce density of APB



# Generation of misfit dislocations: the mechanisms

#### bending of substrate TDs





generation of dislocation half-loops

 $N_{TD} \propto \frac{2}{l_{av}}$ 

 $l_{av}$  - length of MD segment Ge<sub>0.25</sub>Si<sub>0.75</sub>/Si  $l_{av} \sim 10 \ \mu\text{m}$ ;

in lattice-mismatched structures EPD ~  $10^6$  -  $10^{10}$  cm<sup>-2</sup>

# **Critical thickness for MD generation**

Matthews & Blakeslee Journal of Crystal Growth 27 (1974) 118

misfit stress force

dislocation line tension

 $F_{\sigma} \sim b \cdot h_{\rho} \cdot f$  $F_T \sim b^2 \cdot \left[ \ln \left( \frac{h_e}{b} \right) + 1 \right]$ 

 $F_{\sigma} > F_T \longrightarrow$  growth of MD segment

$$F_{\sigma} = F_T \longrightarrow h_e = h_{cr}$$
 (onset of MD generation)

#### equilibrium model



velocity of MD  $\propto$  excess stress (actual stress - stress @ EQ)

strain =  $f(h_e, T, t, ...)$ 

dynamical model







 $h_{\rm e} \approx h_{\rm cr}$ 

 $\sigma$ 

 $F_{\tau}$ 

### **Buffer layers**







# **Threading dislocations in thick buffers**







#### How to speed up reduction of EPD with buffer thickness? 25



### Annealing

thermal strain  $\Leftrightarrow$  driving force for TD movement

Yamamoto & Yamaguchi MRS 116 (1988) 285



Yamaguchi et al. APL <u>53</u> (1988) 2293

# **Filtration of TDs by strained superlattice**

lattice mismatch strain  $\Leftrightarrow$  driving force of bending and movement of dislocations



*Qian et al. J. Electrochem. Soc.* <u>144</u> (1997) 1430



Fig. 5. Cross-sectional bright field micrograph shows the dislocation filtering of the GaSb/AlSb SLS. The majority of threading dislocations are bent by the SLS resulting in low defect density at the top GaSb layer.



- SLS filter efficient for high TD densities
- careful growth needed (no new defects)
- sometimes annealing used in addition

TD density  $< 10^6 - 10^7 \text{ cm}^{-2}$ not achievable in homogeneous buffers

### Epitaxy on "small" substrates



### **Epitaxy on "small" substrates - Nanowires (NWs)**





small NW footprint (small contact area with the substrate)

### GaN NWs on nitridated Si



GaN NWs on AlN/Si





A. Wierzbicka, et al. Nanotechnology 24 (2013) 035703

perfect structural quality of NWs despite their large lattice mismatch with the subgerate

### **Epitaxy on "small" substrates - Nanowires (NWs)**





### **Growth on "thin" substrates – concept of compliant substrates**





equal forces in both parts

$$\sigma_e \times h_e = \sigma_s \times h_s$$

Hook's law

 $\sigma \propto \varepsilon$ 

$$\varepsilon_0 = \varepsilon_e + \varepsilon_s = \frac{\Delta a}{a}$$

$$\frac{\mathcal{E}_e}{\mathcal{E}_0} = \frac{h_s}{h_e + h_s} \quad h_s = h_e \Leftrightarrow \mathcal{E}_e = \mathcal{E}_s$$

partial transfer of strain from epi to substrate larger critical thickness Y.H. Lo, APL <u>59</u> (1991) 2311

$$\frac{1}{h_{cr}} = \frac{1}{h_{cr}^{\infty}} - \frac{1}{h_{s}}$$
  
for  $h_{s} > h_{cr}^{\infty}$ 

 $h_{cr}$  critical thickness  $h_{cr}^{\infty} = h_{cr}(h_s = \infty)$ 

layer

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ubstrate



# How to produce thin substrate membranes?



thin membrane

substrate

Х

### **Requirements:**

- strong bonding with the substrate in the z direction
  to avoid rolling up of the membrane
- weak bonding with the substrate in the x direction
  - sliding of the membrane on the substrate possible
- large area and small thickness of the membrane



De Boeck et al. JJAP <u>30</u> (1991) L423

MBE 1.3 µm GaAs/Si; patterning + mesa release & deposition MBE growth of 1 µm GaAs



PL: no strain in GaAs grown on the membrane large strain in GaAs grown on bulk Si

# Formation of thin substrates by wafer bonding



- connection: T ~ 550° C in  $H_2$  or UHV
- pressure: ~ 200 g/2 inch wafer
- etching to remove the host substrate
- twist angle  $\Theta$ : 0 45°
- very thin layers (10 ML) can be bonded

### **Problems:**

- gas bubbles at the joint leading to cracks
- residual contaminations at the joint
- problems with cleaving
- difficult technology

### **Twist-bonded interface**

Benemara et al. Mat. Sci. Eng.B <u>42</u> (1996) 164



Plane-view TEM of bonded Si wafers  $(\Theta \sim 0.6^{\circ})$ 

dense network of screw dislocations **"soft" connection** distance between dislocations =  $f(\Theta)$ no threading dislocations

### **Universal compliant substrate**



Ejeckam et al. APL <u>70</u> (1997) 1685 film GaAs 10 nm;  $\Theta \sim 17^{\circ}$  in H<sub>2</sub> 300 nm of InGaP on GaAs by MOVPE  $f = 1\% \implies h_e = 30 \times h_{cr}^{\infty}$  (10 nm)



#### Lo et al. Cornell Sci. News 1997; Ejeckam et al. APL <u>71</u> (1997) 776



#### **Conclusion:**

- spectacular <u>laboratory</u> results;
- nice confirmation of the effect of strain transfer from epilayer to the thin substrate
- difficult technology
- no reports on a wide application in the industry

### Methods to reduce defect density in lattice mismatched epitaxial structures - summary



There are no universal method to reduce dislocation density in lattice mismatched heterostructures; The best way is to avoid lattice mismatch – find the suitable substrate !!! 35



### **Epitaxial Lateral Overgrowth - ELO**



MOVPE GaN:  $S = 5 - 20 \ \mu m$ ;  $W = 2 - 5 \ \mu m$ LPE GaAs:  $S = 100 - 500 \ \mu m$ ;  $W = 6 - 10 \ \mu m$ 

### Lecture - 5 April 2023